

Silicon PNP Power Transistors

2SA877 2SA878

DESCRIPTION

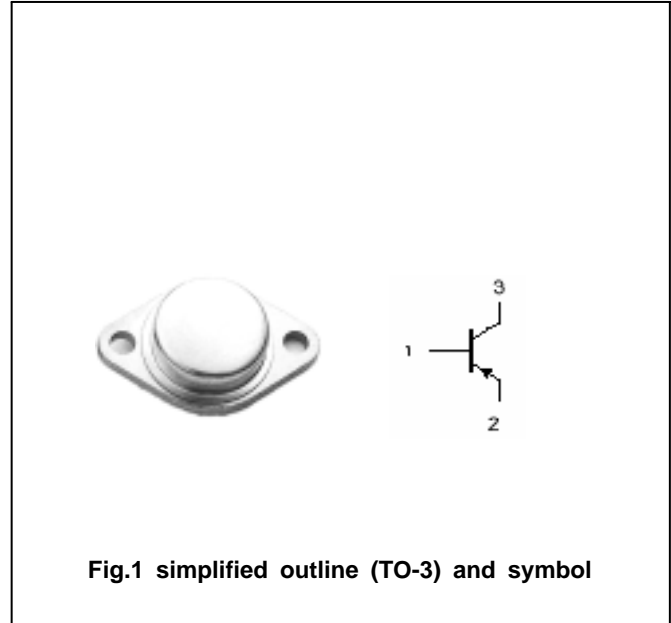
- With TO-3 package
- High power dissipation

APPLICATIONS

- Power amplifier applications
- Recommended for high-power high-fidelity audio frequency amplifier output stage

PINNING(see Fig.2)

PIN	DESCRIPTION
1	Base
2	Emitter
3	Collector

Absolute maximum ratings($T_a =$)

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
V_{CBO}	Collector-base voltage	2SA877	-80	V
		2SA878	-120	
V_{CEO}	Collector-emitter voltage	2SA877	-80	V
		2SA878	-120	
V_{EBO}	Emitter-base voltage	Open collector	-6	V
I_C	Collector current		-10	A
P_C	Collector power dissipation	$T_C=25$	100	W
T_j	Junction temperature		150	
T_{stg}	Storage temperature		-55~150	

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CHARACTERISTICS

T_j=25 unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{(BR)CEO}	Collector-emitter breakdown voltage	2SA877	I _C =-0.1A ; I _B =0			V
		2SA878				
V _{(BR)EBO}	Emitter-base breakdown voltage	I _E =-1mA ; I _C =0	-6			V
V _{CEsat}	Collector-emitter saturation voltage	I _C =-5A; I _B =-0.5A			-2.0	V
I _{CBO}	Collector cut-off current	2SA877				mA
		2SA878				
I _{EBO}	Emitter cut-off current	V _{EB} =-6V; I _C =0			-0.1	mA
h _{FE}	DC current gain	I _C =-3A ; V _{CE} =-4V	50			
C _{OB}	Output capacitance	I _E =0 ; V _{CB} =-10V; f=1.0MHz		255		pF
f _T	Transition frequency	I _C =-1A ; V _{CE} =-12V		15		MHz

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PACKAGE OUTLINE

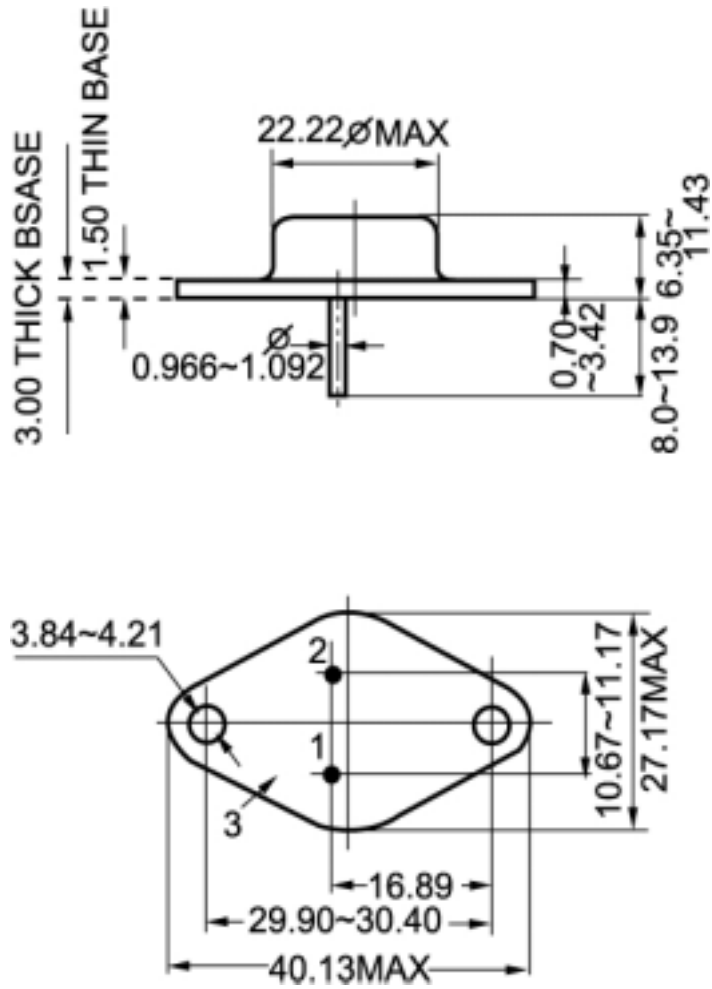


Fig.2 outline dimensions (unindicated tolerance: ± 0.1mm)